


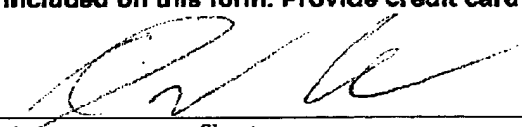
Jan 31 2005 1:32PM CANTOR COLBURN LLP

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<b>CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8)</b> Applicant(s): Bum-Gee BAEK, et al.			Docket No. YOM-0051	
Application No. 10/653,556	Filing Date 9/2/2003	Examiner Hu, Shouxiang	Group Art Unit 2811	
Invention: <b>CONTACT STRUCTURE OF SEMICONDUCTOR DEVICE, MANUFACTURING METHOD THEREOF, THIN FILM TRANSISTOR ARRAY PANEL INCLUDING CONTACT STRUCTURE, AND MANUFACTURING METHOD THEREOF</b>				
<p>I hereby certify that this <u>Amendment (10 pgs); Amendment Transmittal Ltr (Lg Entity)(1 pg)</u>  <small>(Identify type of correspondence)</small></p> <p>is being facsimile transmitted to the United States Patent and Trademark Office (Fax. No. <u>703-872-9306</u>)</p> <p>on <u>January 31, 2005</u>  <small>(Date)</small></p> <div style="text-align: right; margin-top: 40px;"> <u>Paula Currie</u>  <small>(Typed or Printed Name of Person Signing Certificate)</small>    <small>(Signature)</small> </div> <p style="text-align: center; margin-top: 40px;"> <b>Note: Each paper must have its own certificate of mailing.</b> </p>				

P18/REV02

<b>AMENDMENT TRANSMITTAL LETTER (Large Entity)</b>				Docket No. <b>YOM-0051</b>	
Applicant(s): <b>Bum-Gee BAEK, et al.</b>					
Application No. <b>10/653,556</b>	Filing Date <b>9/2/2003</b>	Examiner <b>Hu, Shouxiang</b>	Customer No. <b>23413</b>	Group Art Unit <b>2811</b>	Confirmation No. <b>3225</b>
Invention: <b>CONTACT STRUCTURE OF SEMICONDUCTOR DEVICE, MANUFACTURING METHOD THEREOF, THIN FILM TRANSISTOR ARRAY PANEL INCLUDING CONTACT STRUCTURE, AND MANUFACTURING METHOD THEREOF</b>					
<b><u>COMMISSIONER FOR PATENTS:</u></b>					
Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.					
<b>CLAIMS AS AMENDED</b>					
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	11 -	36 =	0	x \$50.00	\$0.00
INDEP. CLAIMS	2 -	6 =	0	x \$200.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
<b>TOTAL ADDITIONAL FEE FOR THIS AMENDMENT</b>					<b>\$0.00</b>
<input checked="" type="checkbox"/> No additional fee is required for amendment. <input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of _____ <input type="checkbox"/> A check in the amount of _____ to cover the filing fee is enclosed. <input checked="" type="checkbox"/> The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account 06-1130 <input checked="" type="checkbox"/> Any additional filing fees required under 37 C.F.R. 1.16. <input type="checkbox"/> Any patent application processing fees under 37 CFR 1.17. <input type="checkbox"/> Payment by credit card. Form PTO-2038. <b>WARNING: Information on this form may become public. Credit card information should not be included on this form. Provide credit card information and authorization on PTO-2038.</b>					
 _____ Signature			Dated: <b>January 31, 2005</b>		
<b>David A. Fox</b> <b>Registration No.: 38,807</b> <b>Cantor Colburn LLP</b> <b>55 Griffin Road South</b> <b>Bloomfield, CT. 06002</b> <b>Telephone No.: (860) 286-2929</b> <b>Facsimile No.: (860) 286-0115</b>			I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on _____ _____ (Date) _____ Signature of Person Mailing Correspondence _____ Typed or Printed Name of Person Mailing Correspondence		
CC:					

P11LARGEREV09

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: BUM-GEE BAEK, ET AL. )  
Serial No.: 10/653,556 ) Group Art Unit: 2811  
Filed: September 2, 2003 ) Examiner: Hu, Shouxiang  
For: CONTACT STRUCTURE OF )  
SEMICONDUCTOR DEVICE, )  
MANUFACTURING METHOD THEREOF, )  
THIN FILM TRANSISTOR ARRAY PANEL )  
INCLUDING CONTACT STRUCTURE, AND )  
MANUFACTURING METHOD THEREOF )

**AMENDMENT**

Sir:

In response to the Office Action mailed November 3, 2004, Applicants request reconsideration in view of the following amendment and remarks for entry in the above-identified application.